

Product Change Notification - LIAL-12ESQP749

Date:

04 Oct 2019

Product Category:

Simple and Complex Programmable Logic

Affected CPNs:



Notification subject:

CCB 3838 Final Notice: Qualification of MMT as a new assembly site for selected Atmel product of the 19.7k wafer technology available in 28L CLCC (11.4x11.5x2.54mm) package

Notification text:

PCN Status:

Final notification.

PCN Type:

Manufacturing Change

Microchip Parts Affected:

Please open one of the icons found in the Affected CPNs section above.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

Description of Change:

Qualification of MMT as a new assembly site for selected Atmel product of the 19.7k wafer technology available in 28L CLCC (11.4x11.5x2.54mm) package.

Pre Change:

Assembled at ANAP

Post Change:

Assembled at MMT

Pre and Post Change Summary:

	Pre Change	Post Change			
		Microchip Technology			
Assembly Site	Amkor Technology	Thailand			
	Philippine (P1/P2), INC.				
	(ANAP)	(Branch)			
	, ,	(MMT)			
Wire material	Al	Al			
Die attach material	QMI3555	QMI3555			
Lead frame material	Alloy 42	Alloy 42			

Impacts to Data Sheet:

None

Change Impact:

None



Reason for Change:

To improve on-time delivery performance by qualifying MMT as a new assembly site.

Change Implementation Status:

In Progress

Estimated First Ship Date:

November 4, 2019 (date code: 1945)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Time Table Summary:

	October 2019					November 2019			
Workweek	40	41	42	43	44	45	46	47	48
Final PCN Issue Date	X								
Qual Report Availability	X								
Estimated Implementation Date						X			

Method to Identify Change:

Traceability code

Qualification Report:

Please open the attachments included with this PCN labeled as PCN # Qual Report.

Revision History:

October 4, 2019: Issued final notification. Attached the qualification report. Provided estimated first ship date to be on November 4, 2019.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s):

PCN_LIAL-12ESQP749__QUAL REPORT SUMMARY.pdf

Please contact your local <u>Microchip sales office</u> with questions or concerns regarding this notification.

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If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

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Affected Catalog Part Numbers (CPN)

ATF22V10B-10NM/883

ATF22V10B-15NM/883

ATF22V10C-10NM/883

ATF22V10C-15NM/883

ATF750C-10NM/883

ATF750C-15NM/883

Date: Thursday, October 03, 2019